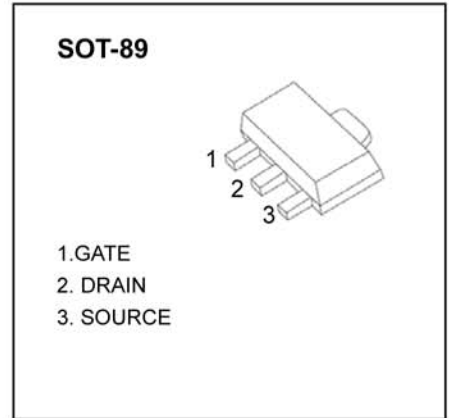


2N7002X MOSFET(N-Channel)

FEATURES

- High density cell design for low $R_{DS(on)}$
- Voltage controlled small signal switch
- Rugged and reliable
- High saturation current capability



MARKING:K72

MAXIMUM RATINGS ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	60	V
I_D	Drain Current	115	mA
P_D	Power Dissipation	500	mW
T_J	Junction Temperature	150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature	-55~+150	$^{\circ}\text{C}$
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	2\theta	$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS($T_a=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate-threshold voltage*	$V_{(GS)th}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1		2	
Gate-body leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 15V$			± 80	nA
Zero gate voltage drain current	I_{DSS}	$V_{DS}=60V, V_{GS}=0V$			80	nA
Drain-source on-resistance*	$R_{DS(on)}$	$V_{GS}=10V, I_D=250mA$	1	1.5	7.2	Ω
		$V_{GS}=4.5V, I_D=200mA$	1	2.0	7.2	
Forward tranconductance*	g_{fs}	$V_{DS}=10V, I_D=200mA$	80		500	ms
Diode forward voltage*	V_{SD}	$I_S=115mA, V_{GS}=0V$	0.55		1.2	V
Turn-on time**	$t_{d(on)}$	$V_{DD}=25V, R_L=50\Omega, I_D=500mA, V_{GEN}=10V, R_G=25\Omega$			20	nS
Turn-off time**	$t_{d(off)}$				40	
Input capacitance**	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1MHz$			50	pF
Output capacitance**	C_{oss}				25	
Reverse transfer capacitance**	C_{rss}				5	

* Pulse Test: Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

** These parameters have no way to verify.